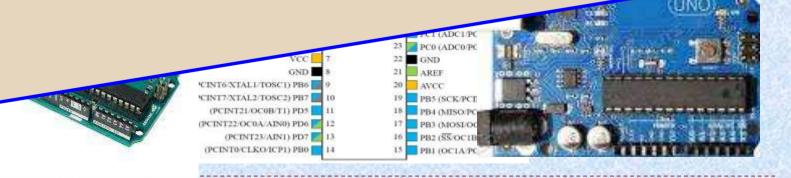


Micro Controller 3.2

ATMega328P SFRs, Addr Modes

FY - DESH - VIT





Status Register of ATMega328P

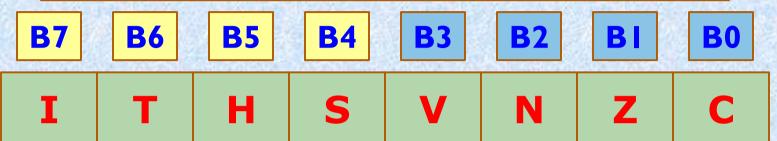
The Status Register contains information about the result of the recent arithmetic instruction executed. This information can be used for conditional decisions.

The Status Register is updated after any ALU operations is over.

The Status Register is not automatically stored when entering an interrupt routine or restored when returning from an interrupt. This must be handled by software.

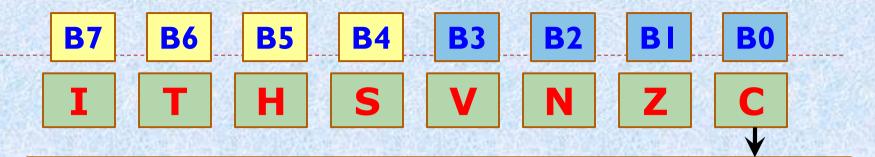


Status Register of ATMega328P 8 bit Register



Bits of the Status Register tell about the latest information of the arithmetic results in the ALU of the Accumulator.





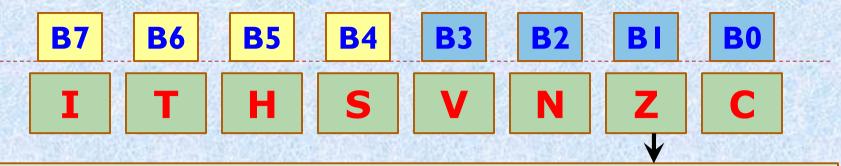
Bit 0 - C Carry Flag

This bit is required in unsigned arithmetic or logic operations.

If $C = 1 \rightarrow a$ Carry is generated out of MSB (9th place).

If $C = 0 \rightarrow$ a Carry is not generated out of MSB.



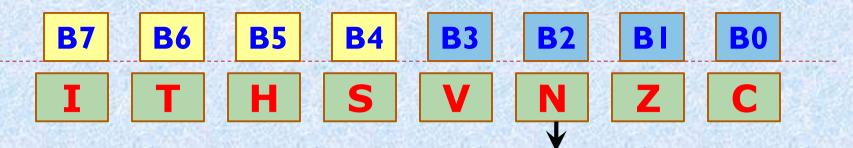


Bit 1 - Z Zero Flag

The Zero Flag Z indicates a zero result in an arithmetic or logic operation.

- **Z bit= 1** means the operation has given answer as 0.
- **Z** bit= 0 means the operation has given answer as non zero number.





Bit 2 - N Negative Flag

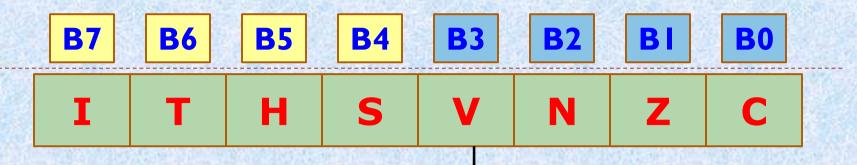
The Negative Flag N indicates a negative result in an arithmetic or logic operation in the Acc.

The MSB in Acc represents sign of the number in signed arithmetic operations.

MSB = $1 \rightarrow -ve$ number. $N = 1 \rightarrow result$ is -ve number

 $MSB = 0 \rightarrow +ve$ number. $N = 0 \rightarrow result$ is +ve number





Bit 3 – V Overflow Flag

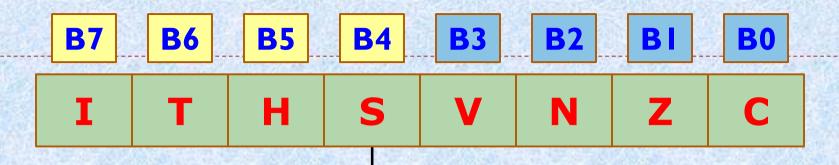
The MSB represents sign of the number in signed arithmetic operations.

 $MSB = 1 \rightarrow a$ -ve number.

 $MSB = 0 \rightarrow a + ve number.$

B3 will be set to 1, if there occurs a Carry from Bit 6 to 7 in Acc. B3 = 0 (cleared) if there is no Carry in Acc.





Bit
$$4 - S$$

Sign Flag,
 $S = V \oplus N$

means exclusive OR.

Thus, the bit 4 i.e. S is set to 1 if N and V differ from each other.



```
Example: 120 + 10 = 130 (decimal)

120=78h and 10=Ah ..... Add

0111 1000

+ 0000 1010
```

1000 0010 = 130 but there is a carry from bit 6 to bit 7, thus bit V will be set to 1.

What about bit N = ??

Bit N will also be set to 1 as MSB = 1 i.e. Negative number!

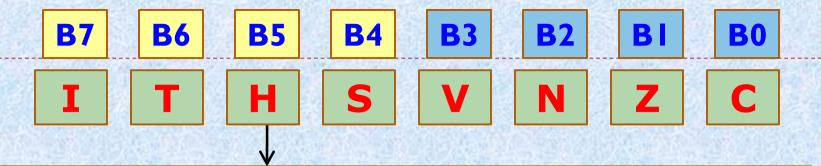
This is absolutely wrong!

 $120 + 10 = 1000 \ 0010 = -2 \ ??$

Status of bit $S = V \oplus N = ? = 0$. This is the correct result.

Thus, Ex-OR will rectify the result.





Bit 5 - H Half Carry Flag

The Half Carry Flag H indicates a Half Carry in some unsigned arithmetic operations. Half Carry Flag is useful in BCD arithmetic. Bit = 1 if there is a Carry from **lower nibble** to **higher nibble** during arithmetic operations.

Bit = 0 if there is no such Carry from LN to HN.

Ex. - Find status of H bit for

1) 0Dh + 15h and 2) 16h + 16h addition.

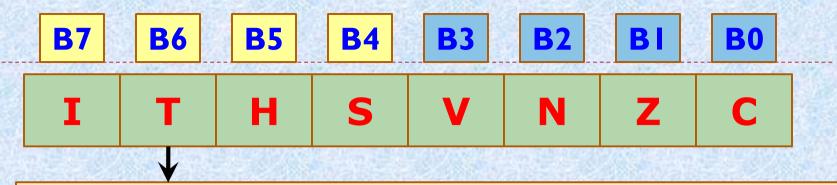


Ex. - Find status of H bit for1) 0Dh + 15h and 2) 16h + 16h addition.

Higher Nibble is same in both cases. What about

H bit =
$$??$$
 H bit = $??$





Bit 6 - T

Bit Transfer - Copy and Storage bit

A bit from some Register from Register file can be copied into T by Bit Store instruction – BST.

OR

A bit in T is copied and loaded into some other Register from Register file. Bit Load instruction – BLD

Thus the T-bit becomes either a source or a destination.



Status Register of ATMega328P B5 B7 B6 B4 B3 B2 B₀ N Bit 7 - I Global Interrupt Enable If set to 1, all the Interrupts are enabled. The individual interrupt enable control is then performed in separate control registers. If the Global Interrupt Enable bit B7 is cleared i.e. made 0, all the interrupts are disabled irrespective of the individual interrupt enable settings.



Memory Structure of ATMega328P

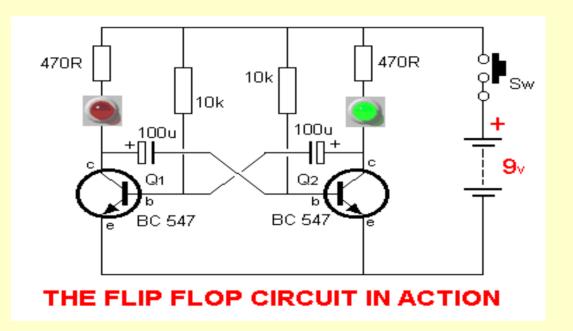
These are the two states for the transistors in the Flip Flop circuit. One transistor is CUT OFF while the other is SATURATED.

A transistor that is OFF is said to be in CUT-OFF condition.

and one that is fully turned ON is said to be SATURATED.



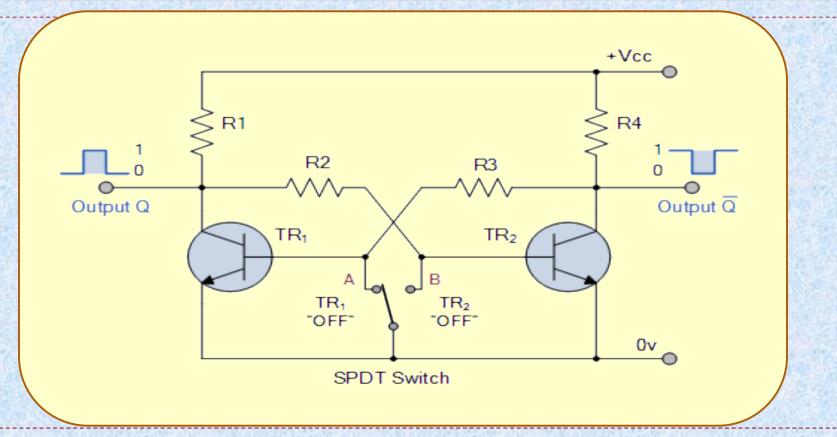
Memory Structure of ATMega328P



Basic memory building block



Memory Structure of ATMega328P





- I) Memory in a microcontroller is a space where
 - a) Data, b) Program Instructions and c) Control instructions are stored.
- 2) Memory is always divided in multiple small parts called as memory locations.

- 3) Every memory location is of same size which will store some data in it.
- 4) To access the data in the memory, each memory location is allotted an identifying unique binary number called as **address**.



- Byte addressable memory The length of data is I Byte only.
- Word addressable memory The length of data is a Word of 2 Bytes,
 - 4 Bytes or 8 Bytes etc. (Architecture specific)
- If more than I Byte of data is to be stored in Byte Addressable Memory, then consecutive locations are used to store the data.



Types of memory used depends upon the specific purpose of memory and the features of that memory.

- 1) Flash Memory –
- 2) Cache Memory –
- 3) EEPROM –
- 4) SRAM -
- 5) DRAM -
- 6) Virtual Memory –



Types of memories – depends upon the specific purpose of memory.

- I) Main or Primary memory contains the program currently being executed by CPU. Moderate speed and Small size. Usually Volatile. Mandatory.
- 2) Associative or Secondary memory Programs currently not being used. Slowest but Large size. This is in the form of CD, DVD, ext hard disc etc. Non-volatile. Optional.
- 3) Cache memory For storage of current and frequently required instructions of the program. Very fast but Smallest in size. Cache is used to reduce the average time to access data from the main memory. Acts as a buffer between CPU and main memory.

- 3) Flash Memory -
- Flash memory is non-volatile advanced type of "EEPROM" (Electrically Erasable Programmable ROM). Mostly used in Microcontrollers and other electronics devices to store the firmware.
- 1) Can be quickly erased and programmed, so called as Flash.
- 2) Performs high speed read, erase and write operations.
- 3) Has a limited number of erase and write cycles. (10000 times) This number is increasing day by day.
- 4) Smaller in size. Limited life.
- 5) Used in Cars, Cameras, Cell phones, Digital diaries etc.
- 6) Two types NAND flash and NOR flash



3) Cache memory – SRAM type - Cache memory has 3 levels. viz. L1, L2 and L3.

Level I Cache

Very Fast, very costly, lies inside the CPU

Level 2 Cache

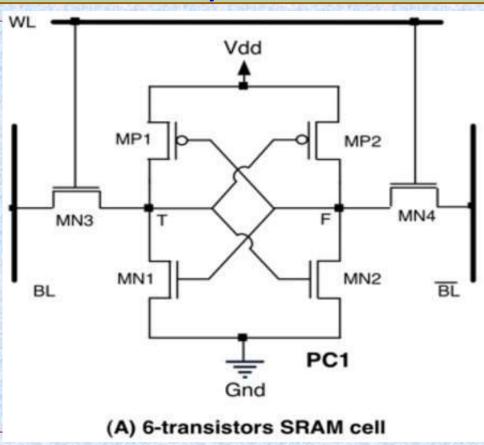
Medium Fast, Moderate cost, lies inside or outside the CPU

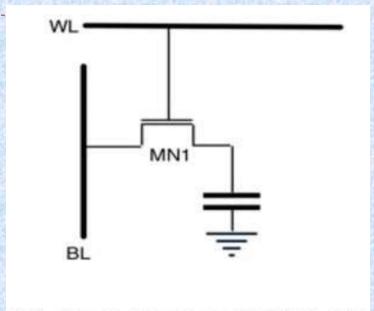
Level 3 Cache

Slow, Low cost, lies outside the CPU, optional

But still all types are faster than RAM







(B) single-transistor DRAM cell



SRAM (Static RAM) Memory Structure DRAM (Dynamic RAM)

- 1) Used as Cache memory
- 2) Very fast speed
- 3) Costliest of all
- 4) Low density (6 Tr per cell but has few cells)
- 5) High manufacturing cost
- 6) Data is stored in the form of voltage developed between two cross coupled 6 or 4 transistors forming an inverter
- 7) Made up of transistors thus, periodic refreshing is not required, thus called as Static.
- 8) Low power consumption.

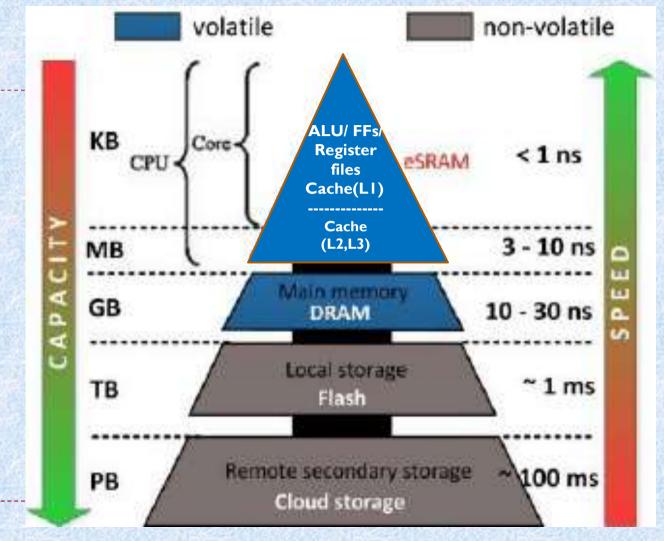
- 1) Used as Main memory
- 2) Fast
- 3) Cheaper than SRAM
- 4) High density (1 Cap per cell but has more cells)
- 5) Low manufacturing cost
- 6) Data is in the form of voltage across a charged Capacitor which gets slowly discharged
- 7) Made up of capacitors, so requires periodic refreshing.(few hundred times in a second)Thus called as Dynamic.
- 8) High power consumption.

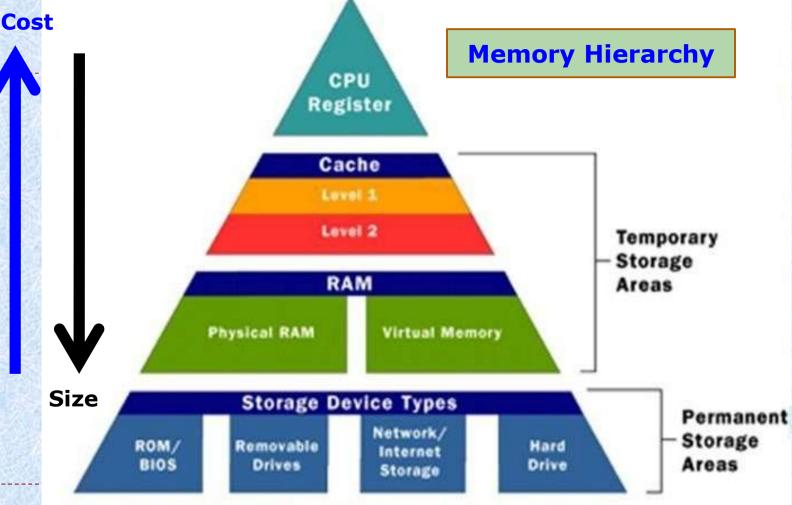


Virtual Memory – Virtual memory is a feature of an operating system (OS) that allows a computer to compensate for shortages of physical memory by temporarily transferring pages of data from random access memory (RAM) to disk storage. Virtual Memory is not included as it is not actual memory.

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Memory Hierarchy





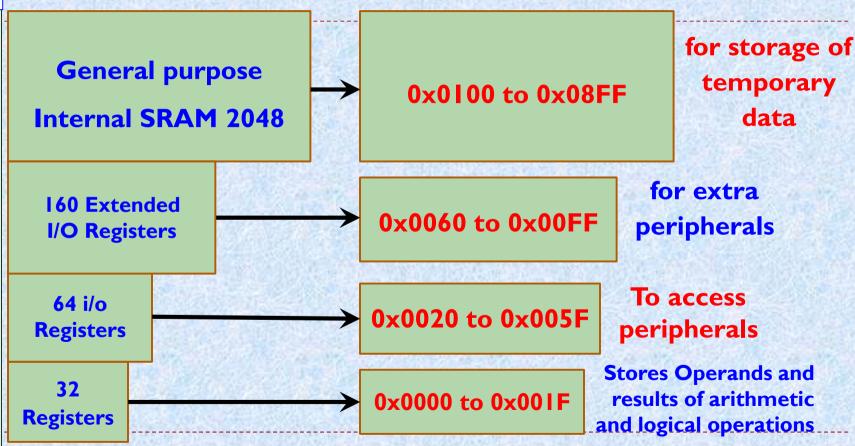
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Memory Structure in ATMega328P





Register File of General purpose Registers of ATMega328P

Register
R3 I
R30
R29
R28
R27
R
R
R4
R3
R2
RI
R0

	Address
	0xIF
	0xIE
	0xID
	0xIC
100	0x1B
	0x
	0x
	0x04
	0x03
	0x02
	0x01
	0x00

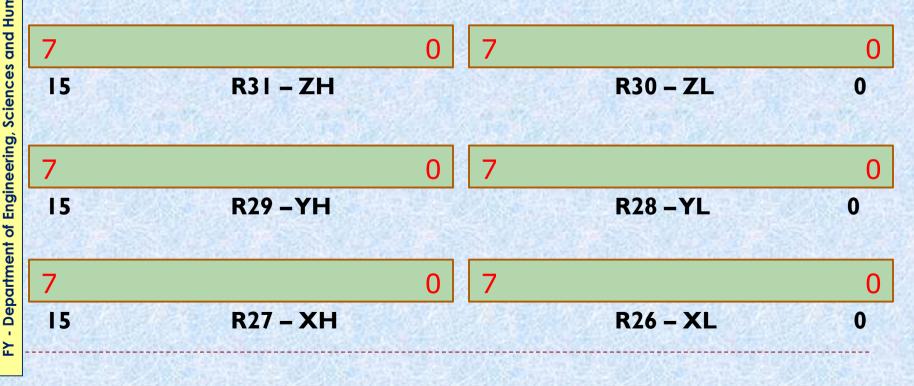
R0 to R31

0x00 to 0x1F

i.e. 32 locations

0x..... means it is a hexadecimal number

The X, Y and Z registers of ATMega328P can additionally work as 16 bit address pointers for indirect addressing to all the remaining registers in the register file. (R26 to R31)





Register **SREG SPH SPL OCRO** • • • • • • • • • • • • **TWDR TWAR TWSR TWBR**

Address 0x5F 0x5E 0x5D0x5C • • • • • • • • • • • • 0x230x22 0x21 0x20

Register File of SFRS Special Function
Registers of
ATMega328P

32 to 95
i.e. next 64 locations
(0x20h to 0x5Fh)



Address

0x00FF
•••••
•••••
•••••
•••••
•••••
•••••
•••••
0×0060

160 extended I/O registers for extra peripherals
0x0060 to 0x00FF



Address

0x08FF
•••••
•••••
0x0100

General Purpose SRAM of ATMega328P

0x0100 to 0x08FF = 2048

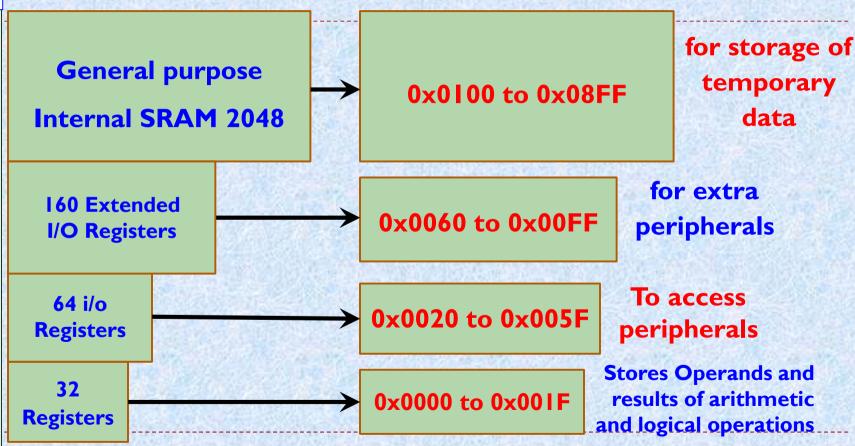
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Memory Structure in ATMega328P





Addressing Modes of AVR (ATMega328P)

Addressing mode – It is a way to tackle / handle the Operand i.e. the Data or a way to deal with the Data.

- 1) Immediate addressing mode
- 2) Register addressing mode
- 3) Direct addressing mode
- 4) Register Indirect addressing mode
- Register Indirect addressing mode with displacement Register Indirect addressing mode (with pre-decrement and post-increment)
- 6) I/O direct addressing mode



Addressing Modes of AVR (ATMega328P)

1) Immediate addressing mode - Single register mode -

deals with the contents of a single register directly.

Format -> Instruction Register, (Number) e.g.

LDI R18, 0x3C; Load immediately

INC R20; Increment

AND R22, 0b00110101 ANDing

Register should be between R16 to R31 only.

Thus LDI R12, 0x3C; is illegal

0 <= Number <= 255 i.e. FFh only (as 8 bit)</pre>

Thus LDI R18, 0x013C; is illegal

Remember!



- 2) Register addressing mode (direct) -
- A) deals with the contents of two registers.

Format → Instruction Register I, Register 2

ADD R18, R19; Add contents of R19 to R18, result stored in R18

SUB R20, R21; Subtract contents of R21 from R20, result in R20

MOV R22, R23; copy contents of R23 to R22

Register should be between R16 to R31

0 <= Number <= 255 (as 8 bit)





- 3) Direct addressing mode -
- B) Deals data between a register and a memory location.

Format > Instruction Register, address

OR Instruction address, Register e.g.

LDS R20, 0x0045 data at memory location 0045H will be

loaded into R20 (Load from Data Space)

Contents of R20 will be stored at memory

location 0045H (STore direct to Data Space)

STS 0x0045, R20



3) Direct addressing mode -

LDS 0x0095, 0x0045

> what is meaning of this?

This is illegal, as a data can not be directly loaded into a memory location. OR can not be moved from one memory location into another memory location.

It has to be transferred through a register only !!

Remember!



LDS R22, 0x0045

→ what is meaning of this?

LDI R22, 0x0045

→ what is meaning of this?

LDS R22, 0x0045

(Load from data space)

→ Data is at memory location 45H which will be moved into R22.

LDI R22, 0x0045

(Load immediate)

→ Actual data is the number 45H which will be moved into R22



4) Register indirect addressing mode – uses X, Y or Z registers as pointers to indicate the memory location where data is stored.

e.g.

LDI XL, 0x40

→ 40H is loaded in lower of X

LDI XH, 0x02

→ 02H is loaded in higher of X

LDS R20, X

→ (Load indirect) contents of memory

location 0240H are copied into R20



4) Register indirect with displacement :-

e.g.

LD R18, Y

→ control will go to Y, (consider YL and YH)

find the 16 bit number in it,

treat it as address,

find the data at that address and

load that data in R18.

LDD R19, $Y+0x10 \rightarrow Load$ contents of memory location Y+0x10 to R19

STD X+0x05, R20 \rightarrow Contents of R20 are stored at memory location X+0x05



Find the output of Answer = R18 = 2Bh

R22 = 2Bh

Y = 0135h

0x0135 = 2Bh

e.g.

LDI R22, 0x2B

(Load immediate) 55

LDI YL, 0x35

LDI YH, 0x01

55

STS 0x0135, R22

55

(Store Direct to SRAM)

(Load Direct from SRAM)

What are contents of R18, R22, Y, 0x0135 after execution of all the instructions above?

What is the actual data in each location and register?

LDS R18, Y



Transport a data of 3 different nos. to 3 consecutive memory locations. How to do this?

LDI Location 1, Data 1

LDI Location 2, Data 2

LDI Location 3, Data 3





LDI Reg 1, Data 1

LDS Location 1, Reg 1

LDI Reg 2, Data 2

LDS Location 2, Reg 2

LDI Reg 3, Data 3

LDS Location 3, Reg 3



Right ?????





How to transport a data of 300 different nos. to 300 consecutive memory locations?

How to do this?

- 5) A) Register indirect with post-increment -
- 5) B) Register indirect with pre-decrement -



5) A) Register indirect with post-increment -

```
LDI R16, 0x20
                             (for e.g. counter set = 20)
          LDI R20, 0xFF
          OUT DDRB, R20
                             (All pins of Port B defined as output)
         LDI ZL, 0x90
                             (Lower byte of Z = 90)
         LDI ZH, 0x00
                             (Higher byte of Z = 00)
L1:
         LDS R20, Z
                                       (Go to memory location 0090 pointed by Z
and copy the data to R20)
          INC ZL
                             (increment pointer: 90 \rightarrow 91)
          OUT PORTB, R20
                             (contents of R20 i.e. data is sent to Port B)
         DEC R16
                             (decrement counter: 20 \rightarrow 19)
          BRNE L1
                             (if R16 is not equal to 0, continue the loop -
                                       BRNE = Branch (Loop) if not equal to 0)
```



5) A) Register indirect with pre-decrement / increment -

LD RI7, -Z

: Data in Z will be decremented first and then loaded in R17

e.g. suppose Z contains a 16 bit address. Just e.g. Z = 0234h.

Thus, data at the address 0233h will be loaded in R17

After this, Z will have 0233h in it. (which is actually an address)

LD R17, + Z

: Data in Z will be incremented first and then loaded in R17

e.g. suppose Z contains a 16 bit address. e.g. Z = 0234h.

Thus, data at the address 0235h will be loaded in R17.

After this, Z will have 0235h in it. (which is actually an address)



5) B) Register indirect with post-increment / decrement -

LD R17, Z+

: Data in Z will be loaded in R17 and then incremented by I.

e.g. Suppose Z contains a 16 bit address. e.g. Z = 0234h.

Thus, data at the address 0234h will be loaded in R17.

After this, Z will have 0235h as data in it (which is actually an address)

: Data in Z will be loaded in R17 and then decremented by 1.

e.g. Suppose Z contains a 16 bit address. e.g. Z = 0234h.

Thus, data at the address 0234h will be loaded in R17

After this, Z will have 0233h as data in it (which is actually an address)

LD R17, Z-

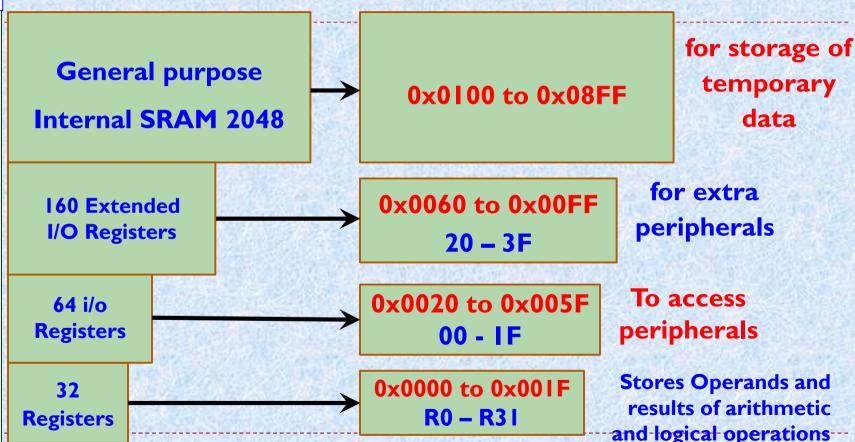
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Memory Structure in ATMega328P





6) I/O direct addressing mode – This is a Special addressing mode to access the 64 i/o registers in the ATMega328P from 0x0020 to 0x005F.

Only IN and OUT instructions are used.

To understand the **I/O direct addressing mode**, we should first know **DDR**, **PORT** & **PIN** registers.

and Humanities

The 3 I/O registers - DDRx, PORTx and PINx

There are 3 very important registers used to handle / control the i/o operations of different ports using GPIO pins. They are called as i/o registers.

- 1) Data Directions Register DDRx
- 2) Port Output Register - PORTx
- Pin Input Register - PINx
 - where x is the name of the port (B, C or D)



Data Directions Register – DDRx of ATMega328P

Data Directions Register – DDRx (....x is the port B, C or D)

All the digital pins can work as an input pin or an output pin.

DDRx will decide whether a pin would be used as i/p pin or o/p pin.

If the corresponding bit in the DDR is HIGH (1), the pin will work as OUTPUT pin – **eligible to Deliver the data.**

If the bit in the DDR is LOW (0), the pin will work as INPUT pin – **eligible to Accept the data.**



DDR of ATMega328P

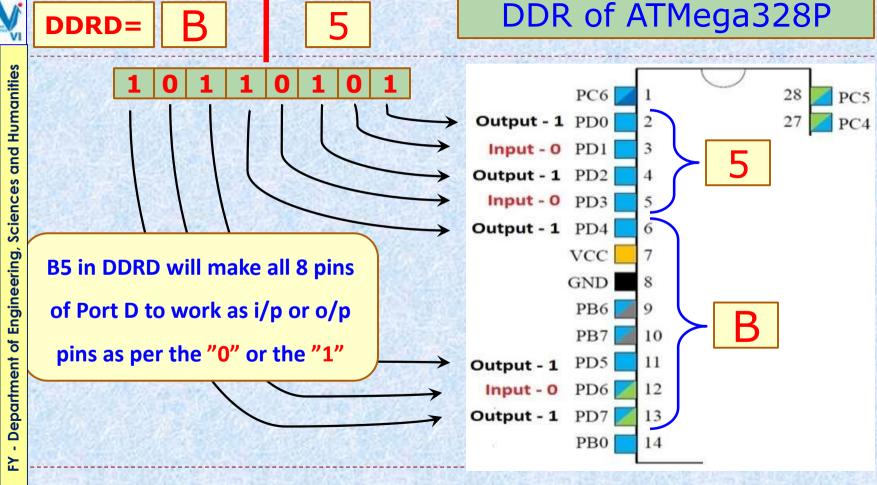
e.g. DDRD = 0xB5; A Hexa no. B5 is pushed in DDRD OR

DDRD = 0b1011 0101; A binary no. 10110101 is pushed in DDRD

DDRD7	DDRD6	DDRD5	DDRD4	DDRD3	DDRD2	DDRDI	DDRD0		
1	0	1	1	0	1	0	1		
o/p	i/p	o/p	o/p	i/p	o/p	i/p	o/p		
Direction of Data will be decided by DDRD									
13	12	11	6	5	4	3	2 M	uC pins	
	1			1		1			

1 =output pin = deliver the data 0 =input pin =accept the data

output and input w.r.t. whom ??





PORTx and PINx registers of ATMega328P

Once the DDR decides whether a pin is configured for outputting the data or inputting the data

then the PORTx register decides whether a pin should deliver a HIGH output or a LOW output.

Similarly the PINx register decides whether a pin should accept a HIGH input or a LOW input.

DDRB	DDRC	DDRD
PORTB	PORTC	PORTD
PINB	PINC	PIND



PORTx of ATMega328P

e.g. PORTD = 0xA6; A Hexa no. A6 is pushed in PORTD OR

PORTD = **0b1010 0110**; A binary no. **10100110** is pushed in **PORTD**

PORTD7	PORTD6	PORTD5	PORTD4	PORTD3	PORTD2	PORTDI	PORTD0
1	0	1	0	0	1	1	0
High	Low	High	Low	Low	High	High	Low

What is the Direction of the above Data?

The direction will be decided by the DDRD.

(1 = output pin = deliver the data) (0 = input pin = accept the data)



PINx of ATMega328P

e.g. PIND = 0xC7; A Hexa no. C7 is pushed in PIND OR

PIND = 0b1100 0111; A binary no. 1100 0111 is pushed in PIND

PIND7	PIND6	PIND5	PIND4	PIND3	PIND2	PINDI	PIND0
1	1	0	0	0	1	1	1
High	High	Low	Low	Low	High	High	High

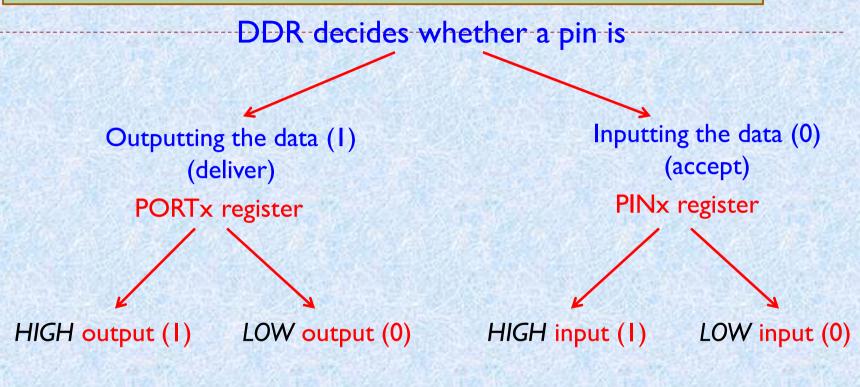
What is the Direction of the above Data?

The direction will be decided by the DDRD.

```
(1 = output pin = deliver the data)
(0 = input pin = accept the data)
```



PORTx and PINx registers of ATMega328P





PORTx of ATMega328P

```
e.g. 1
                                               DDRD
                                               (1 = output pin = deliver the data)
                                               (0 = input pin = accept the data)
                        = 0b 1 0 1 1 0 0 0 1
DDRD
PORTD
                        = 0b 1 0 0 1 0 0 0 1
                                                    1 = High
                                                            0 = Low
                        = 0b 1 * 0 1 * * * 1
OUTPUT = ??
e.g. 2
DDRD
                        = 0b 1 0 1 1 0 0 0 1
PORTD
                        = 0b 1 0 0 1 0 1 0 1
OUTPUT = ??
                        = 0b 1 * 0 1 * * * 1
```

DDRx will decide the direction and PORTx will decide High or Low.

N.

PINx of ATMega328P

```
e.g. 1
                                               -DDRD
                                                (1 = output pin = deliver the data)
                                                (0 = input pin = accept the data)
                        = 0b 1 0 1 1 0 0 0 1
DDRD
                        = 0b 1 0 1 0 1 0 1 0
PIND
                                                   1 = High
                                                             0 = Low
INPUT = ??
                        = 0b * 0 * * 1 0 1 *
e.g. 2
                        = 0b 1 1 1 1 0 0 0 0
DDRD
PIND
                        = 0b 1 1 1 1 1 1 1 1
INPUT = ??
                        = 0b * * * * 1 1 1 1
```

PINx can <u>not change</u> the properties of the pins which are already decided by the DDRx. MuC can read only from those pins which are decided as i/p pins.

* pins will enter in Tri state.



Example -

Read the data and store in memory

IN R6, PIND : Data coming at PIN register of D will loaded in R6

STS 0x0200, R6 : This data will be stored at the memory location 0x0200

Read the data and write to a Port

IN R7, PIND : Data coming at PIN register of D will loaded in R7

OUT PORTB, R7 :This data will be written at the Port B as output.

Q.1) In order to run above instructions, what is a pre-requisite?

Q.2) What is the role of DDRD and DDRB?

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